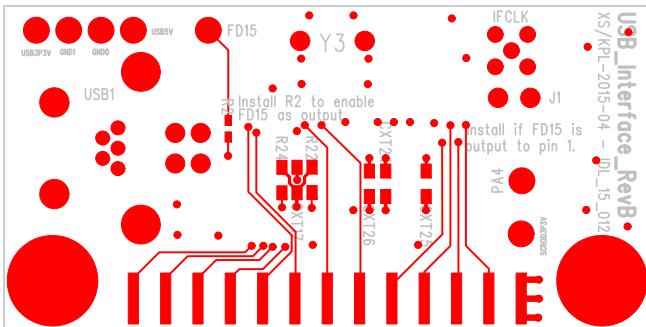


Notes:

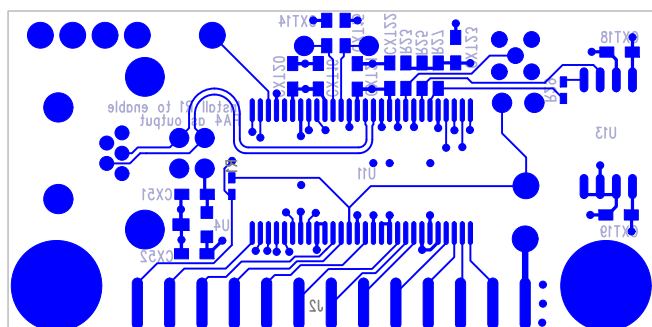
Install R2 and pin header to output FD15 to pin 7.
Install R1 to output PA4 to pin 1.

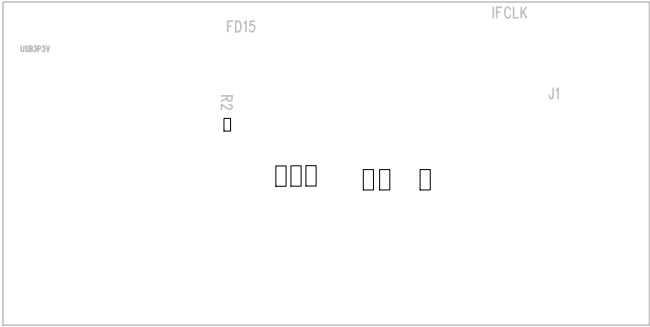


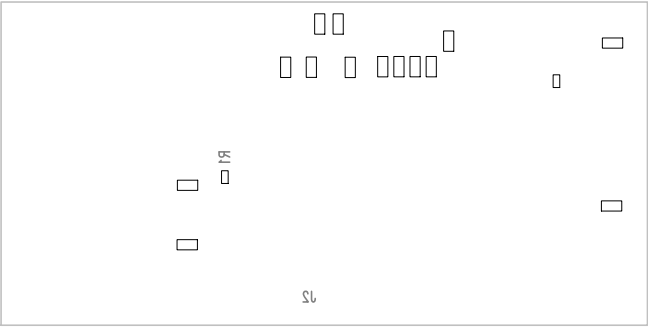
Board Stack Up

Layers:	Thickness(mils):
Top	1.35 (1 oz copper)
Dielectric	4.3
PWR	1.35 (1 oz copper)
Dielectric	36.6
GND	1.35 (1 oz copper)
Dielectric	4.3
Bottom	1.35 (1 oz copper)

board material = FR4
overall board dimensions = 2 in * 1 in
solder mask color = green
slicscreen color = white
Total Board thickness = 62mils

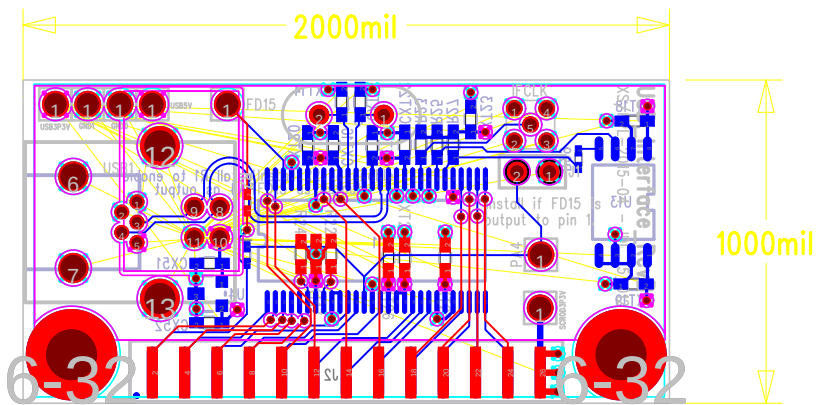






Notes:

Install R2 and pin header to output FD15 to pin 7.
Install R1 to output PA4 to pin 1.



Board Stack Up

Layers:	Thickness(mils):
Top	1.35 (1 oz copper)
Dielectric	4.3
PWR	1.35 (1 oz copper)
Dielectric	36.6
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board material = FR4
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slicscreen color = white
Total Board thickness = 62mils

